Features



### Complete, +5V-Powered, Isolated, Dual RS-232 Transceiver Module

#### **General Description**

The MAX252 complete, electrically-isolated, dual RS-232 transmitter/receiver system requires no external components. By combining many functions in one package, the cost and complexity of an isolated digital interface are greatly reduced.

A single +5V supply powers both sides of the interface. Transceivers, optocouplers, and a transformer in one low-cost package provide a complete interface up to 9600 bits/sec. Additional pins provide low-power shutdown and a high-impedance state for both transmitter outputs.

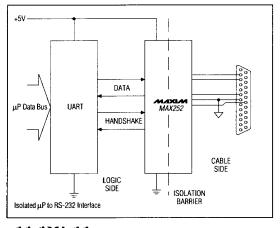
The MAX252A withstands 130V<sub>RMS</sub> (continuous), 1260V<sub>RMS</sub> (1 min.) or 1520V<sub>RMS</sub> (1 sec.) and is intended for applications where very high transient voltages, differential ground potentials or noise may be encountered. The MAX252A is UL recognized. The MAX252B is intended for less stringent applications and is rated for 500V<sub>RMS</sub> (1 min.) or 600V<sub>RMS</sub> (1 sec.).

Receivers and fine drivers (transmitters) meet EIA RS-232D and CCITT V.28 specifications. The MAX252 is supplied in 40-pin plastic DIP packages in commercial (0°C to +70°C) and extended (-40°C to +85°C) temperature ranges.

#### **Applications**

High-Noise Environments
Automatic Test Equipment
Differential Ground Potentials

#### **Typical Application**



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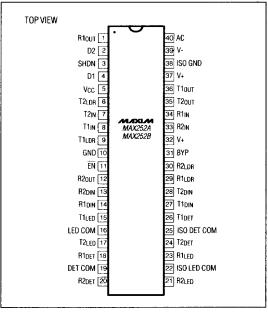
♦ Isolated Data Interface

- No External Components
- ♦ Single +5V Supply
- ♦ 50µW Low-Power Shutdown
- Two Transmitters and Two Receivers
- ♦ UL Recognized (MAX252A) File E118032 to UL1577

#### **Ordering Information**

PART	TEMP. RANGE	PIN-PACKAGE
MAX252ACHL	0°C to +70°C	40 Plastic Module
MAX252BCHL	0°C to +70°C	40 Plastic Module
MAX252AEHL	-40°C to +85°C	40 Plastic Module
MAX252BEHL	-40°C to +85°C	40 Plastic Module

#### Pin Configuration



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#### **ABSOLUTE MAXIMUM RATINGS**

Voltages with respect to GND (pin 10) Supply Voltage, VCC0.3V to +6V Input Voltage
Pins 3, 7, 8, 11, 13, 14, 18, 200.3V to (Vcc +0.3V)
Voltages with respect to ISO GND (pin 38)
RS-232 Input Voltage (pins 33, 34)30V to +30V
RS-232 Applied Output Voltage (pins 35, 36)15V to +15V
Pins 32, 37 (V+)
Pins 24, 26, 31
RS-232 Transmitter outputs may be shorted individually and
indefinitely to ISO GND.

LED Forward Continuous Current (pins 15, 17, 21, 23)30mA
Power Dissipation
Plastic DIP (derate 10mW/°C above +70°C) 650mW
Operating Temperature Ranges:
MAX252ACHL/BCHL 0°C to +70°C
MAX252AEHL/BEHL40°C to +85°C
Storage Temperature Range65°C to +150°C
Lead Temperature (soldering, 10 sec.) +300°C
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Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational section of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

(VCC = +5V ±10%, TA = TMIN to TMAX, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
ISOLATION (Note 1)	L							
	Viso	T <sub>A</sub> = +25°C MAX252A	1sec.	1520			VRMS	
			1 min. (Note 2)	1260				
Test Voltage			Continuous (Note 2)	130				
		MAX252B	1 sec.	600				
			1 min. (Note 2)	500				
Leakage Current		10 sec., V <sub>ISO</sub> = 5 T <sub>A</sub> = +25°C	10 sec., VISO = 500VRMS, 60Hz, TA = +25°C		10	50	μARMS	
Isolation Resistance		T <sub>A</sub> = +25°C 500V <sub>DC</sub>	T <sub>A</sub> = +25°C		10 <sup>10</sup>		Ω	
Capacitance		OV			10		pF	
POWER SUPPLY								
Operating Supply Current	loc	T <sub>A</sub> = +25°C, SHDN = 0V	T1IN, T2IN, R1IN, R2IN = VCC	I	60	90	⊢ mA	
			T1 <sub>IN</sub> , T2 <sub>IN</sub> , R1 <sub>IN</sub> , R2 <sub>IN</sub> = 0		8	15		
Shutdown Supply Current	Ics	SHDN = 1V			1	10	μА	
EN, SHDN Input Current	IEN, ISHDN	Input = GND to Vcc			0.001	1	μА	
TTL/CMOS INPUTS/OUTPUTS								
TTL/CMOS Input Pull-Up Current	lР	V <sub>IN</sub> = 0V			4	20	μА	
TTL/CMOS Output Voltage Low	VOL	IOUT = 3.2mA				0.4	٧	
TTL/CMOS Output Voltage High	VoH	Iout = -1.0mA		3.5			٧	
Input Logic Threshold High	ViH	T1 <sub>IN</sub> , T2 <sub>IN</sub> , EN, SHDN			1.8	2.4	V	
Input Logic Threshold Low	VIL	T1 <sub>IN</sub> , T2 <sub>IN</sub> , <del>EN</del> , SHDN		0.8	1.3		٧	
Input Hysteresis		T1 <sub>IN</sub> , T2 <sub>IN</sub>			0. 5		V	
Leakage Current, Output Disabled	IL	T1 <sub>IN</sub> , T2 <sub>IN</sub> ; EN or SHDN = VCC				10	μΑ	
Input Capacitance	CIN	T1 <sub>IN</sub> , T2 <sub>IN</sub>			5		pF	

Note 1:	Pins	1-20 tied	together	and pi	ins 21-40	tied together.

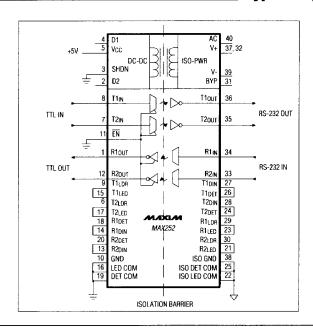
Note 2: Value derived from 1 sec. test.

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### **ELECTRICAL CHARACTERISTICS (continued)** ( $V_{CC} = +5V \pm 10\%$ , $T_A = T_{MIN}$ to $T_{MAX}$ , unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
RS-232 CHARACTERISTICS							
RS-232 Output Voltage Swing	Vpp	T1ουτ, T2ουτ, R <sub>L</sub> = 3k <b>Ω</b> to ISO	±5	±7.2		V	
RS-232 Output Leakage Current		V+ = V- = 0V or SHDN = Vcc, T1out, T2out = ±15V	-10		+10	μА	
RS-232 Input Threshold High		R1 <sub>IN</sub> , R2 <sub>IN</sub>		1.8	3.0	٧	
RS-232 Input Threshold Low		R1 <sub>IN</sub> , R2 <sub>IN</sub>	0.6	1.2		٧	
RS-232 Input Hysteresis		R1 <sub>IN</sub> , R2 <sub>IN</sub>		0.6		٧	
RS-232 Input Resistance		R1 <sub>IN</sub> , R2 <sub>IN</sub> , T <sub>A</sub> = +25°C	3		7	kΩ	
Transmitter Output Slew Rate	SR	$R_L = 3k\Omega$ , $C_L = 2500pF$ Sample Tested Measured from +3v to -3V or -3V to +3V		3	30	V/µs	
D	tR	RS-232 to TTL		24			
Propagation Delay	tτ	TTL to RS-232		20		μs	
Transmission Rate		Sample Tested $R_L = 3k\Omega$ $C_L = 2500pF$	9600	19200		Bits/sec.	

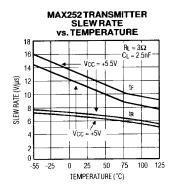
#### **Typical Operating Circuit**

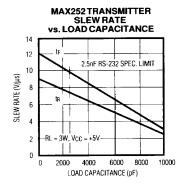


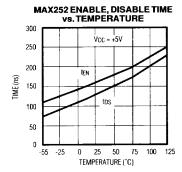
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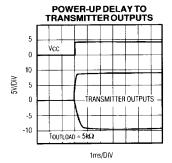
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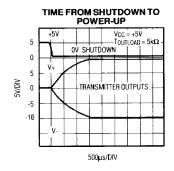
Typical Operating Characteristics











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#### Pin Description

PIN#	NAME	FUNCTION
1	R1out	Receiver #1 Output; TTL/CMOS logic levels
2	D2	Internal Connection. Leave this pin unconnected. Do not ground.
3	SHDN	Shutdown. When high, turns off the oscillator and disconnects driver inputs. Ground for normal operation.
4	D1	Internal Connection, Leave this pin unconnected. Do not ground.
5	Vcc	+5V Supply Voltage
6	T2 <sub>LDR</sub>	Transmitter #2 LED Driver
7	T2 <sub>IN</sub>	Transmitter #2 Input; TTL/CMOS logic levels
8	T1 <sub>IN</sub>	Transmitter #1 Input; TTL/CMOS logic levels
9	T1LDR	Transmitter #1 LED Driver
10	GND	Ground
11	ĒN	Output Enable. If High, T1LDR, T2LDR, R10UT, and R2OUT go to high- impedance state. Ground for normal operation.
12	R2 <sub>OUT</sub>	Receiver #2 Output; TTL/CMOS logic levels
13	R2DIN	Receiver #2 Detector Input
14	R1DIN	Receiver #1 Detector Input
15	T1 <sub>LED</sub>	T1 LED Anode Input
16	LED COM	Common T1LED, T2LED Cathode. Tie to Ground.
17	T2LED	T2 LED Anode Input
18	R1DET	R1 Photodiode Cathode Output
19	DET COM	Common R1DET, R2DET Anode. Tie to Ground.
20	R2DET	R2 Photodiode Cathode Output

PIN#	NAME	FUNCTION
21	R2LED	R2 LED Cathode Input
22	ISO LED COM	Common R1LED, R2LED Cathode. Tie to Isolated Ground.
23	R1LED	R1 LED Cathode Input
24	T2DET	T2 Photodiode Anode Output
25	ISO DET COM	Common T1DET, T2DET LED Anode. Tie to Isolated Ground.
26	T1DET	T1 Photodiode Anode Output
27	T1DIN	Transmitter #1 Detector Input
28	T2 <sub>DIN</sub>	Transmitter #2 Detector Input
29	R1LDR	Receiver #1 LED Driver
30	R2 <sub>LDR</sub>	Receiver #2 LED Driver
31	BYP	Internal Connection. Leave this pin unconnected. Do not ground.
32	V+	Isolated Positive Supply
33	R2IN	RS-232 Receiver #2 Input
34	R1 <sub>IN</sub>	RS-232 Receiver #1 Input
35	T2 <sub>OUT</sub>	RS-232 Transmitter #2 Output
36	T1out	RS-232 Transmitter #1 Output
37	V+	Isolated Positive Supply
38	ISO GND	Isolated Ground
39	V-	Isolated Negative Supply Voltage
40	AC	Internal Connection. Leave this pin unconnected. Do not ground.

#### Isolation Applications

The MAX252 is intended for industrial communications and control applications where voltage transients, differential ground potentials or high noise may be encountered. The MAX252A withstands 130VnMs (continuous), 1260VnMs (1 min.) or 1520VnMs (1 sec.). For less stringent applications, the MAX252B is rated at 500VnMs (1 min.) or 600VnMs (1 sec.). For applications requiring higher isolation ratings or transmission rates greater than 9600 baud, Maxim recommends the MAX250 and MAX251 device set that uses external optocouplers and transformer.

Figure 1 shows the typical interconnection for a complete 9600 bits/sec. transceiver. Important layout considerations include:

- \* For maximum isolation, the isolation line through the center of Figure 1 should not be breached; connections from each side should be kept separate.
- \* Optocoupler outputs (pins 18, 20, 24, and 26) are high-impedance nodes, so connecting traces should be

R10UT 1 40 AC 39 V-38 ISO GND D1 4 T1001 T2LDR 6 T20UT R1in T2IN 7 MAXIM R2<sub>IN</sub> T1IN 8 MAX252 T1LDR 9 32 V+ GND 10 31 BYP ĒΝ R2LDR 30 R1LDR R2OUT 12 T2DIN R1DIN T1DIN T1LED 15 T1DET LED COM ISO DET COM T2LED 1 T2DET RIDET 118 R1LED DET COM ISO LED COM R2DET 2 R2LED ISOLATION BARRIER

Figure 1. Typical Interconnections

as short as possible to minimize stray capacitance and maximize data transfer rate; shunt capacitance seen by each pin should not exceed 10pF.

The MAX252 pin out enables optimal printed circuit board layout by minimizing interconnect lengths and crossovers. Figure 2 shows the preferred layout, which is strongly recommended for 9600 bits/sec. applications. Note the position of the ground traces, particularly the protection of pin 20 by the wraparound from pin 19.

#### Isolation Example

Figure 3 illustrates how to isolate an existing RS-232 interface by inserting a MAX252 and MAX233 in series. Both devices invert while translating RS-232 to TTL and TTL to RS-232 levels. Since there is no net inversion, the circuit functions like two plain pieces of wire, but with 1520V<sub>RMS</sub> (at 1 sec.) isolation between the ports.

#### **Detailed Description**

The MAX252 contains two integrated circuits, four optocouplers, four capacitors, two diodes, and a small transformer. Together, these provide a complete, isolated, dual RS-232 transmitter and receiver. The non-isolated or logic side of the interface transfers logic signals to and from the optocouplers, while the isolated or cable side transfers data between the optocouplers and RS-232

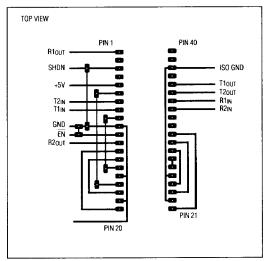


Figure 2. Preferred Layout

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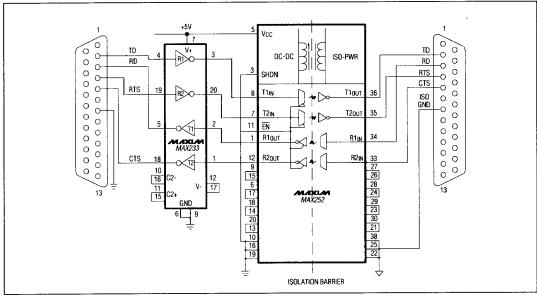


Figure 3. RS-232 Isolation Adapter from a Single +5V Supply

transmitters (line drivers) and receivers. The MAX252 also contains an isolation transformer and drive circuitry to supply power to the isolated side of the interface.

On the logic side of the MAX252 are four identical non-inverting drivers whose outputs may be used either as optocoupler LED drivers or as TTL/CMOS logic outputs. Each driver input (T1<sub>IN</sub>, T2<sub>IN</sub>, R1<sub>DIN</sub>, R2<sub>DIN</sub>) has a weak 4µA internal pull-up current source, and 0.5V hysteresis to improve noise rejection; logic thresholds for the driver inputs conform to standard TTL/CMOS specifications.

The RS-232 side of the interface includes two line drivers and receivers along with circuitry to translate these levels to optocoupler signals. The RS-232 inputs (R1IN, R2IN) and outputs (T1ouT, T2ouT) conform to EIA RS-232D and CCITT V.28 specifications. The inputs to the RS-232 line drivers (T1DIN, T2DIN), which are normally strapped to the internal optoisolators, are TTL/CMOS compatible.

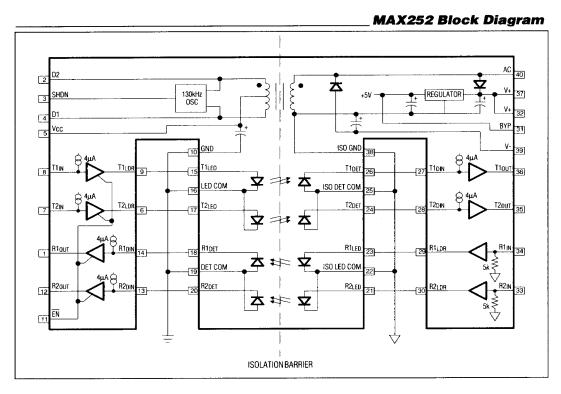
Also included are an OUTPUT ENABLE control ( $\overline{\text{EN}}$ ) and a SHUTDOWN pin (SHDN).  $\overline{\text{EN}}$  places all driver outputs in a high-impedance state when driven high. SHDN, when pulled high, performs the following functions:

- 1) Turns off the 130kHz oscillator, removing power from the RS-232 side of the interface.
- 2) Places T1<sub>OUT</sub> and T2<sub>OUT</sub> in a high-impedance state.
- 3) Disables the 4µA pull-up currents at the logic-side driver inputs (T1<sub>IN</sub>, T2<sub>IN</sub>, R1<sub>DIN</sub>, R2<sub>DIN</sub>).
- 4) Resets logic-side driver outputs (T1<sub>LDR</sub>, T2<sub>LDR</sub>, R1<sub>OUT</sub>, R2<sub>OUT</sub>) to low.
- 5) Reduces power consumption to 50µW.

#### \_ Module Product Reliability

For reliability data on Maxim's Module Product Line, see Reliability Report RR-3A.

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